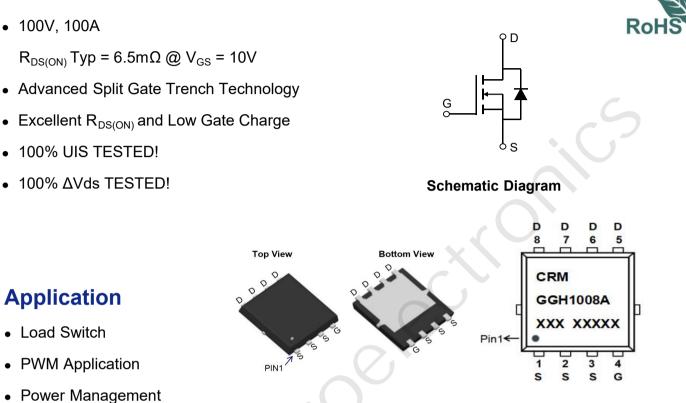


CRMGGH1008A

N-Channel 100V, 6.5mΩ Typ. Power MOSFET

Description

Features



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGH1008A	CRMGGH1008A	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		100	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	100	А
Ι _D		T _c = 100°C	60	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		400	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		144	mJ
P _D	Power Dissipation	T _C = 25°C	147	W
$R_{ ext{ ext{ ext{ ext{ ext{ ext{ ext{ ext$	Thermal Resistance, Junction to Case		0.85	°C/W
T _J , T _{stg}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250 μ A, $V_{\rm GS}$ = 0V	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2.4	3	3.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 30A	-	6.5	8.4	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	1757	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 50V, f = 1MHz	-	985	-	pF
C _{rss}	Reverse Transfer Capacitance		Χ-	12	-	pF
Q _g	Total Gate Charge	(_	29	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 50V$, $I_{D} = 20A$	J .	6.8	-	nC
Q_gd	Gate Drain("Miller") Charge	$v_{\rm DS} = 30 v, v_{\rm D} = 20 A$	-	8.4	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	8.4	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 50V	-	9.4	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 6 Ω	-	27	-	ns
t _f	Turn-Off Fall Time		-	18	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	100	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	400	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	45	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 15A, di/dt = 100A/us	-	53	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

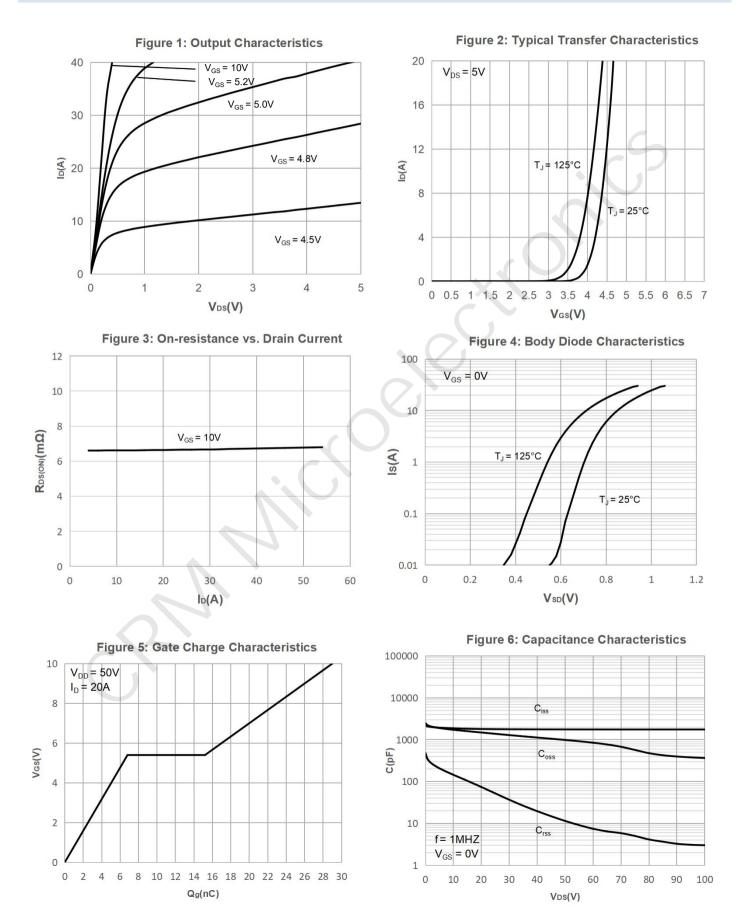
2. E_{AS} condition: Starting T_J=25°C, V_{DD}=50V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=24A

3. Pulse Test: Pulse Width \leqslant 300µs, Duty Cycle \leqslant 0.5%.



CRMGGH1008A N-Channel 100V, 6.5mΩ Typ. Power MOSFET

Typical Performance Characteristics

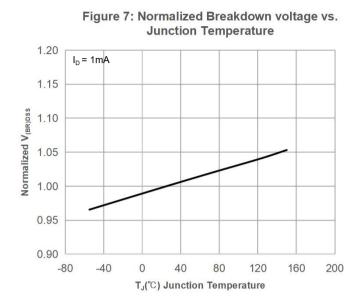




CRMGGH1008A

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Typical Performance Characteristics





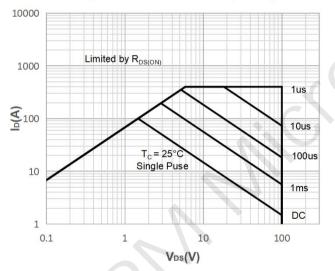
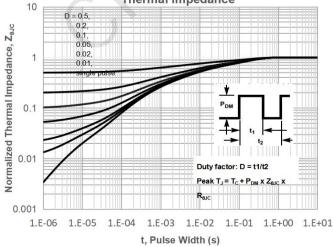


Figure 11: Normalized Maximum Transient Thermal Impedance



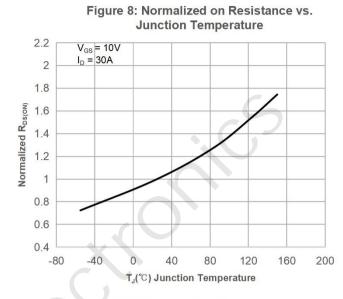


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

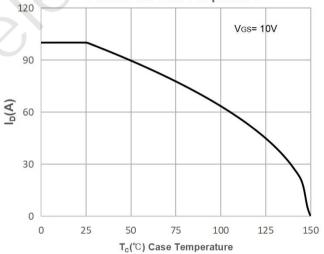
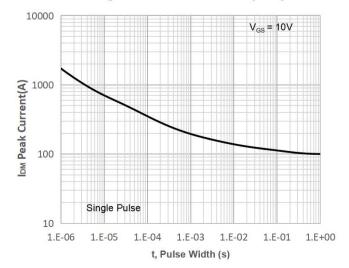


Figure 12: Peak Current Capacity





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Test Circuit

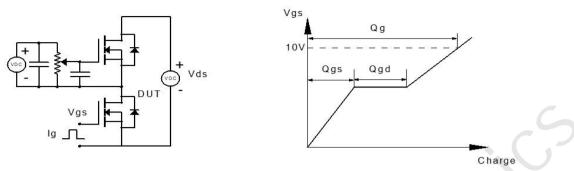


Figure 1: Gate Charge Test Circuit & Waveform

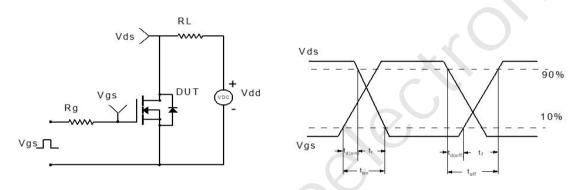


Figure 2: Resistive Switching Test Circuit & Waveform

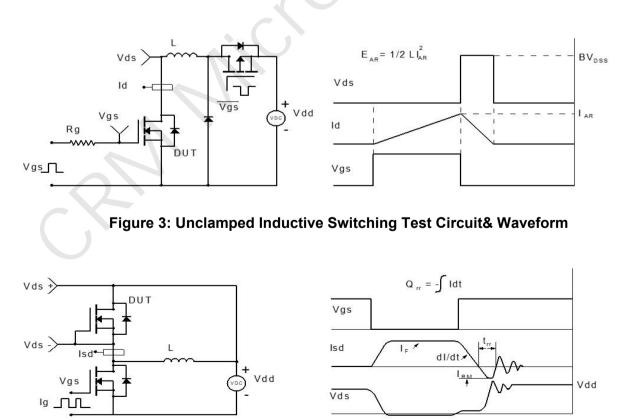
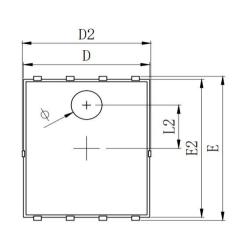


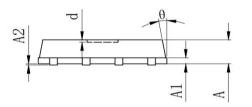
Figure 4: Diode Recovery Test Circuit & Waveform

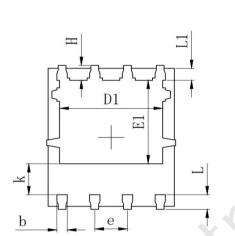


CRMGGH1008A N-Channel 100V, 6.5mΩ Typ. Power MOSFET

Package Mechanical Data(PDFN5x6-8L)







SYMBOL	MILLIMETER				
	MIN	Typ.	MAX		
Α	0.900	1.000	1. 100		
A1	0.254 REF.				
A2	0~0.05				
D	4.824	4.900	4.976		
D1	3. <mark>910</mark>	4.010	4. 110		
D2	4.924	5.000	5.076		
E	5. <mark>9</mark> 24	6.000	6.076		
E1	3. 375	3. 475	3. 575		
E2	5. 674	5.750	5.826		
b	0.350	0.400	0.450		
е	1.270 TYP.				
L	0.534	0.610	0.686		
LI	0. 424	0.500	0.576		
L2	1.800 REF.				
k	1.190	1.290	1. 390		
Н	0.549	0.625	0.701		
θ	8°	10°	12°		
ф	1.100	1.200	1.300		
d			0.100		

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